



CERAMIC BALUN

RF Transformer

NCS2-282+

Mini-Circuits

50Ω 625 to 2815 MHz 1:2 Ratio

FEATURES

- Wideband, 625 to 2815 MHz
- Miniature size 0805, 0.079"x0.049"x0.033"
- LTCC construction
- Industry leading combination of size/performance
- Low cost
- Aqueous washable



Generic photo used for illustration purposes only

CASE STYLE: GE0805C-9

APPLICATIONS

- GPS
- WCDMA
- PCS
- Cellular

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

PRODUCT OVERVIEW

Mini-Circuits new RF Transformer, NCS2-282+ converts single ended, unbalanced RF signals, that propagate through systems, to balanced signals that are required for many semiconductor devices. The NCS series offers a low cost small size alternative for matching, A/D converters, System on Chips, and up/down converters. The outstanding phase and amplitude unbalance make this component a versatile building block for use in a variety of systems and sub-system designs.

KEY FEATURES

Feature	Advantages
Wideband, 625 to 2815 MHz	Supporting wideband, 625 to 2815 MHz make this RF Transformer applicable for use in higher level integrated components such as A/D converters and system on a chip.
Small Size	Offered in the EIA-0805 package size, the NCS2-282+ offers an industry leading combination of size and performance. The small footprint (2.0 mm x 1.25 mm) allows for reduced parasitics in systems with improved performance and simplified layout.





ELECTRICAL SPECIFICATIONS AT 25°C

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Units
Impedance Ratio (Secondary/Primary)			2		
Frequency Range		625		2815	MHz
Insertion Loss ¹	625 - 2815	—	1	2	dB
Amplitude Unbalance	625 - 2815	—	0.8	1.8	dB
Phase Unbalance ²	625 - 2815	—	6	15	Degree
Return Loss	625 - 2815	—	11	—	dB

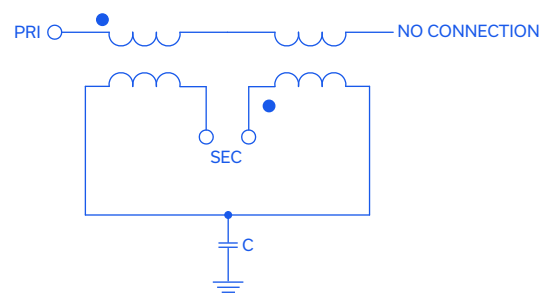
1. Reference Demo Board TB-NCS2-282+
 2. Relative to 180°

MAXIMUM RATINGS

Parameter	Ratings
Operating Temperature	-55°C to 125°C
Storage Temperature	-55°C to 125°C
RF Power ³	3W at 25°C

3. Passband rating, derate linearly to 1W at 125°C ambient.
 Permanent damage may occur if any of these limits are exceeded.

CONFIGURATION R

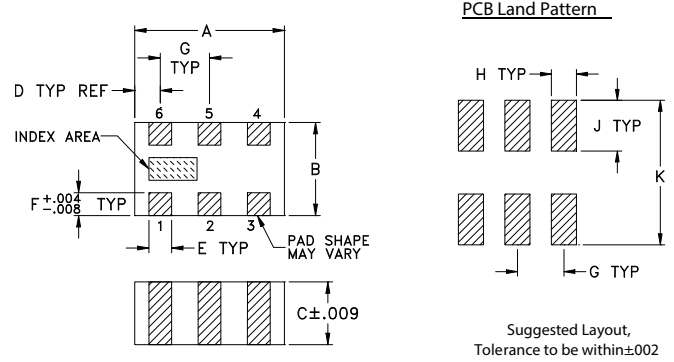




PAD CONNECTIONS

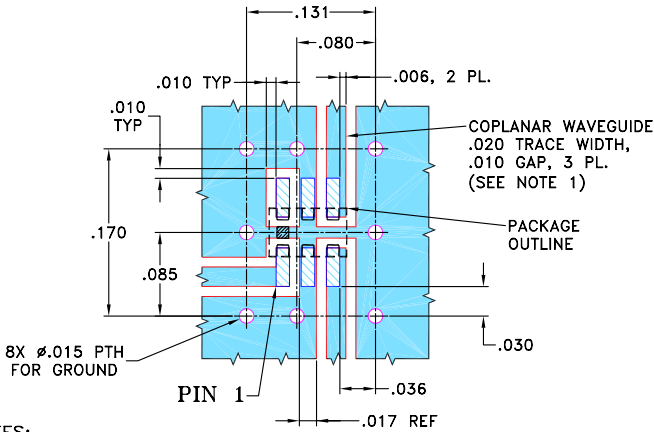
Unbalanced Port (IN)	1
GND OR DC feed + RF GND	2
Balanced port (Out 1)	3
Balanced port (Out 2)	4
GND	5
NO CONNECTION	6

OUTLINE DRAWING



PRODUCT MARKING: N/A

DEMO BOARD MCL P/N: TB-NCS2-282+ SUGGESTED PCB LAYOUT (PL-264)



NOTES:

- COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS $.010'' \pm .001''$. COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
 - BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).
 DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

OUTLINE DIMENSIONS (Inches/mm)

A	B	C	D	E	F
.079	.049	.033	.014	.012	.012
2.0	1.24	0.84	0.36	0.30	0.30
G	H	J	K		wt
.026	.014	.039	.110		grams
0.66	0.36	1.00	2.80		.008

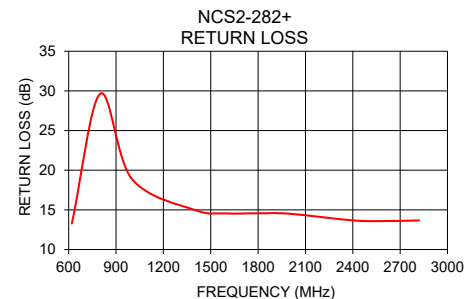
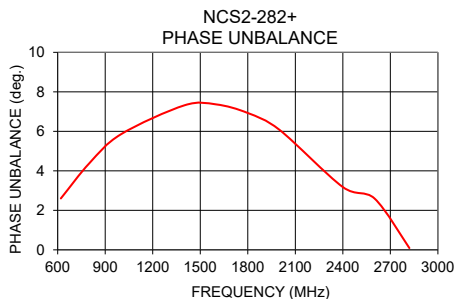
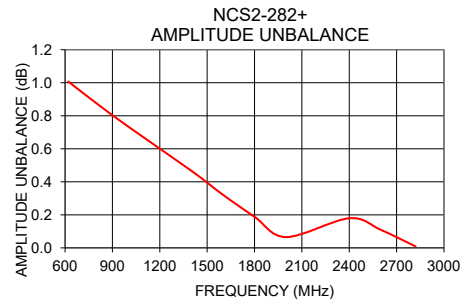
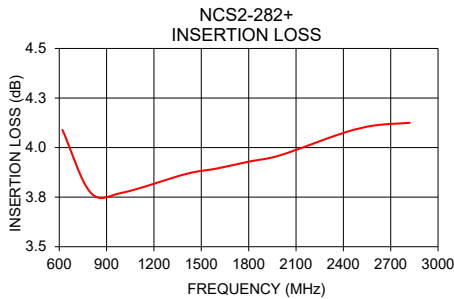
TAPE & REEL INFORMATION: F74



TYPICAL PERFORMANCE DATA³

Frequency (MHz)	Insertion Loss (dB)	Input Return Loss (dB)	Amplitude Unbalance (dB)	Phase Unbalance (deg)
620	4.09	13.29	1.01	2.60
625	3.93	13.53	0.77	3.95
800	3.77	29.64	0.87	4.39
1000	3.77	18.90	0.73	5.85
1400	3.87	14.97	0.47	7.32
1600	3.89	14.55	0.32	7.36
1800	3.93	14.57	0.19	6.93
2000	3.96	14.51	0.07	6.08
2400	4.07	13.67	0.18	3.18
2600	4.11	13.59	0.11	2.60
2815	4.05	15.13	0.47	0.35
2820	4.12	13.67	0.01	0.09

3. Measured with Agilent E5071B network analyzer using impedance conversion and port extension.



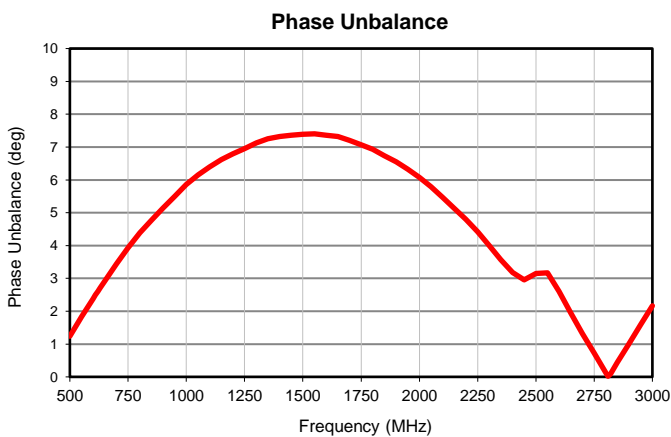
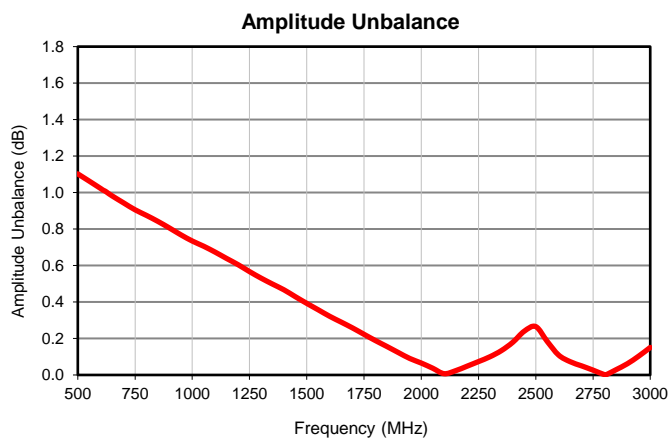
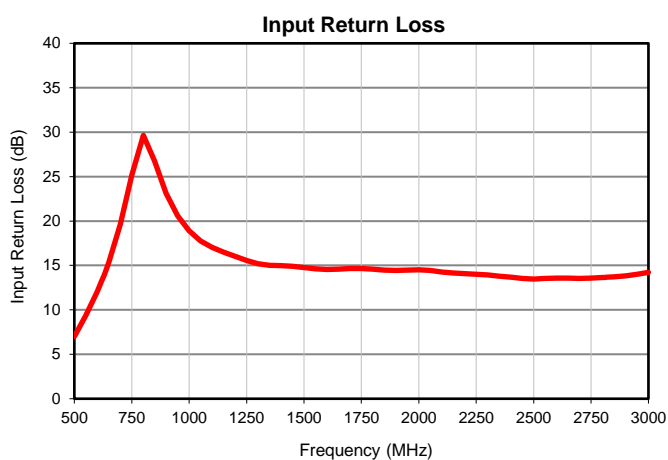
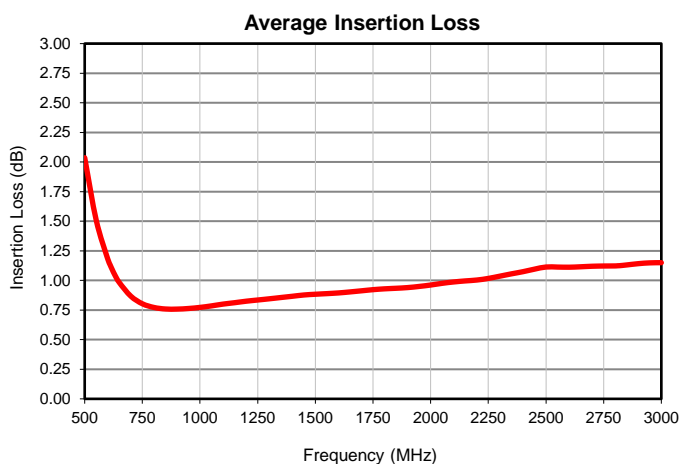
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Typical Performance Data

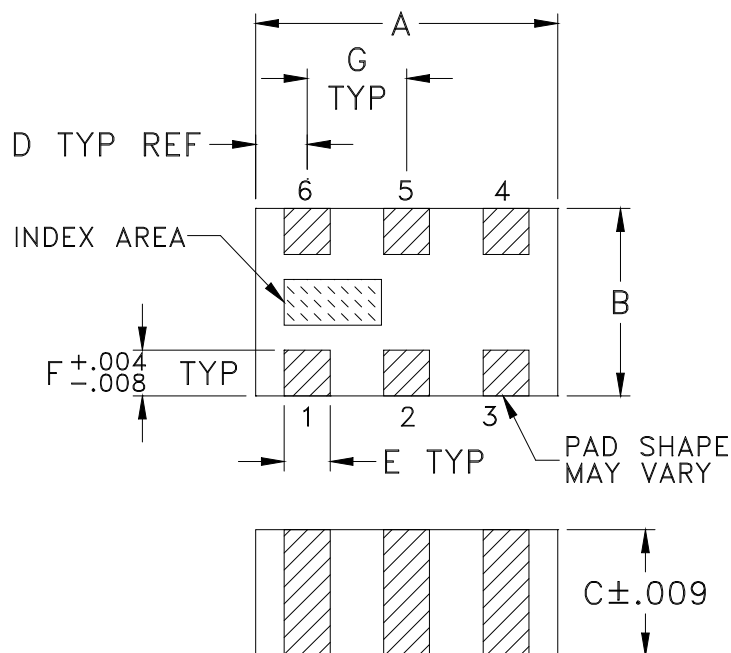
FREQUENCY (MHz)	AVERAGE INSERTION LOSS (dB)	INPUT RETURN LOSS (dB)	AMPLITUDE UNBALANCE (dB)	PHASE UNBALANCE ⁽¹⁾ (deg.)
500	2.04	6.99	1.10	1.24
550	1.51	9.35	1.06	1.84
600	1.18	12.06	1.02	2.38
610	1.13	12.66	1.01	2.49
620	1.09	13.29	1.01	2.60
630	1.05	13.94	1.00	2.71
650	0.98	15.36	0.98	2.93
700	0.87	19.63	0.94	3.44
750	0.80	25.18	0.91	3.93
800	0.77	29.64	0.87	4.39
850	0.76	26.76	0.84	4.77
900	0.76	23.11	0.81	5.15
950	0.76	20.60	0.77	5.50
1000	0.77	18.90	0.73	5.85
1050	0.79	17.77	0.71	6.15
1100	0.80	17.04	0.67	6.40
1150	0.81	16.51	0.64	6.62
1200	0.82	16.02	0.60	6.79
1250	0.83	15.55	0.57	6.96
1300	0.84	15.20	0.53	7.12
1350	0.86	15.03	0.50	7.25
1400	0.87	14.97	0.47	7.32
1450	0.88	14.90	0.43	7.36
1500	0.88	14.76	0.39	7.39
1550	0.89	14.61	0.36	7.40
1600	0.89	14.55	0.32	7.36
1650	0.90	14.59	0.29	7.32
1700	0.91	14.65	0.26	7.20
1750	0.92	14.64	0.22	7.07
1800	0.93	14.57	0.19	6.93
1850	0.93	14.47	0.16	6.74
1900	0.94	14.42	0.12	6.55
1950	0.95	14.47	0.09	6.33
2000	0.96	14.51	0.07	6.08
2050	0.98	14.43	0.04	5.79
2100	0.99	14.27	0.01	5.47
2150	1.00	14.14	0.02	5.13
2200	1.00	14.07	0.05	4.79
2250	1.02	14.02	0.07	4.41
2300	1.04	13.92	0.10	4.00
2350	1.06	13.80	0.13	3.57
2400	1.07	13.67	0.18	3.18
2450	1.10	13.53	0.24	2.95
2500	1.11	13.47	0.27	3.15
2550	1.11	13.54	0.18	3.17
2600	1.11	13.59	0.11	2.60
2650	1.12	13.58	0.07	1.94
2700	1.12	13.55	0.05	1.32
2750	1.12	13.57	0.03	0.73
2800	1.12	13.64	0.00	0.13
2810	1.12	13.66	0.00	0.02
2820	1.12	13.67	0.01	0.09
2850	1.13	13.72	0.03	0.44
2900	1.14	13.83	0.06	1.02
2950	1.15	14.02	0.10	1.59
3000	1.15	14.21	0.15	2.17

⁽¹⁾ Relative to 180°

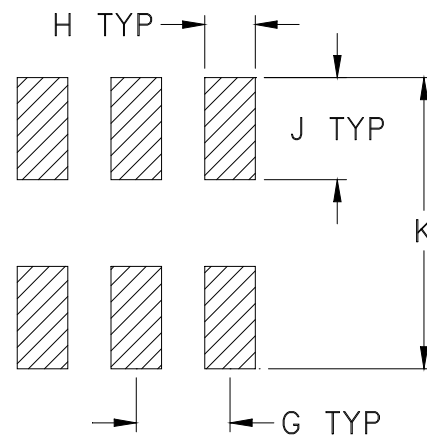
Typical Performance Data



Outline Dimensions



PCB Land Pattern



Suggested Layout,
Tolerance to be within ± 0.002

CASE #	A	B	C	D	E	F	G	H	J	K	WT.GRAM
GE0805C-9	.079 (2.00)	.049 (1.25)	.037 (0.95)	.014 (0.35)	.012 (0.30)	.012 (0.30)	.026 (0.65)	.014 (0.35)	.039 (1.00)	.110 (2.80)	.008

Dimensions are in inches (mm). Tolerances: 2Pl. $\pm .01$; 3 Pl. $\pm .005$

Notes:

- Open style, ceramic base.
- Termination finish: For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
For RoHS-5 Case Styles: Tin-Lead plate over Nickel plate. All models, no (+) suffix.



P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site



The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

RF/IF MICROWAVE COMPONENTS

Tape & Reel Packaging TR-F114

DEVICE ORIENTATION IN T&R



ILLUSTRATION 1

Applicable Case Styles	
GE0805C	JC0603C
GE0805C-1	JC0603C-4
GE0805C-1AP	JC0603C-6
GE0805C-7	
GE0805C-9	
GE0805C-10	
GE0805C-11	
GE0805C-12	



ILLUSTRATION 2

Applicable Case Styles	
GE0805C-2	JC0603C-1
GE0805C-3	JC0603C-2
GE0805C-4	JC0603C-3
GE0805C-5	JC0603C-5
GE0805C-6	JC0603C-7
GE0805C-8	
GE0805C-15	

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
8	4	7	Small quantity standards (see note)	20
				50
				100
				200
				500
			Standard	1000
			Standard	4000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



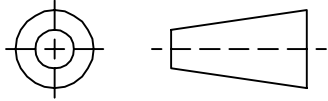
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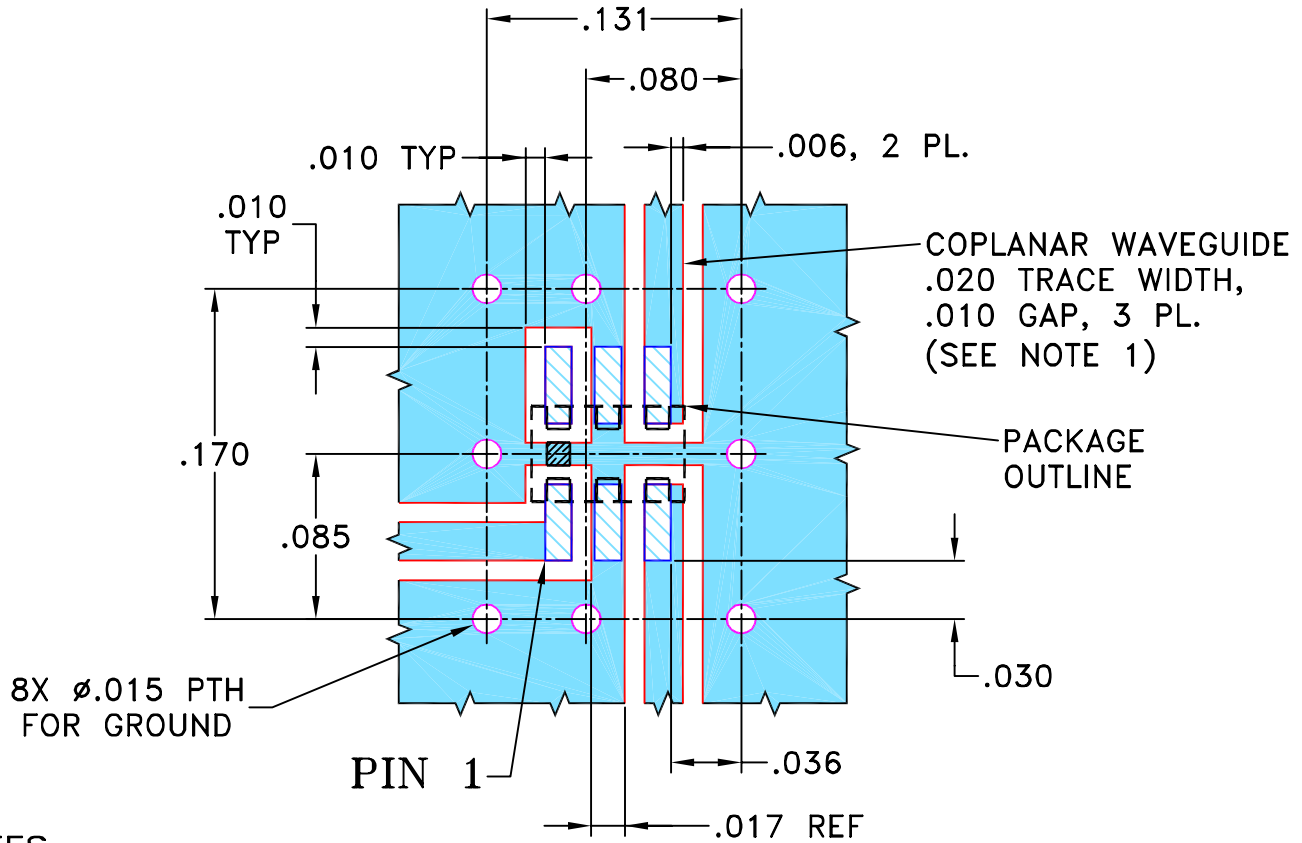
THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M109549	NEW RELEASE	01/31/07	PW	DJ

SUGGESTED MOUNTING CONFIGURATION
FOR GE0805C-1 CASE STYLE, "ry" PIN CONNECTION.

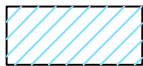


NOTES:

1. COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS .010" ± .001". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.



DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).



DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED	INITIALS		DATE
DIMENSIONS ARE IN INCHES TOLERANCES ON: 2 PL DECIMALS ± 3 PL DECIMALS ± .005 ANGLES ± FRACTIONS ±	DRAWN	PW	01/30/07
	CHECKED	IL	01/31/07
	APPROVED	DJ	01/31/07



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13 Neptune Avenue
Brooklyn NY 11235

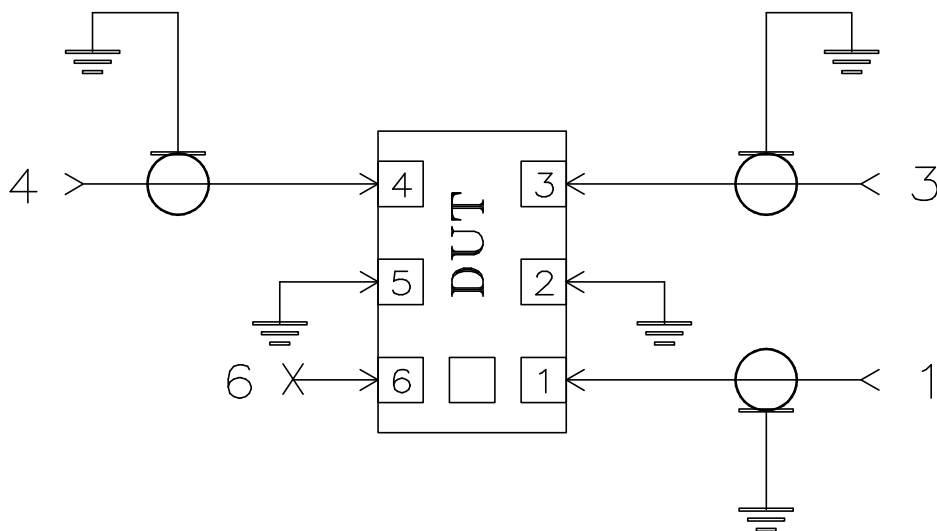
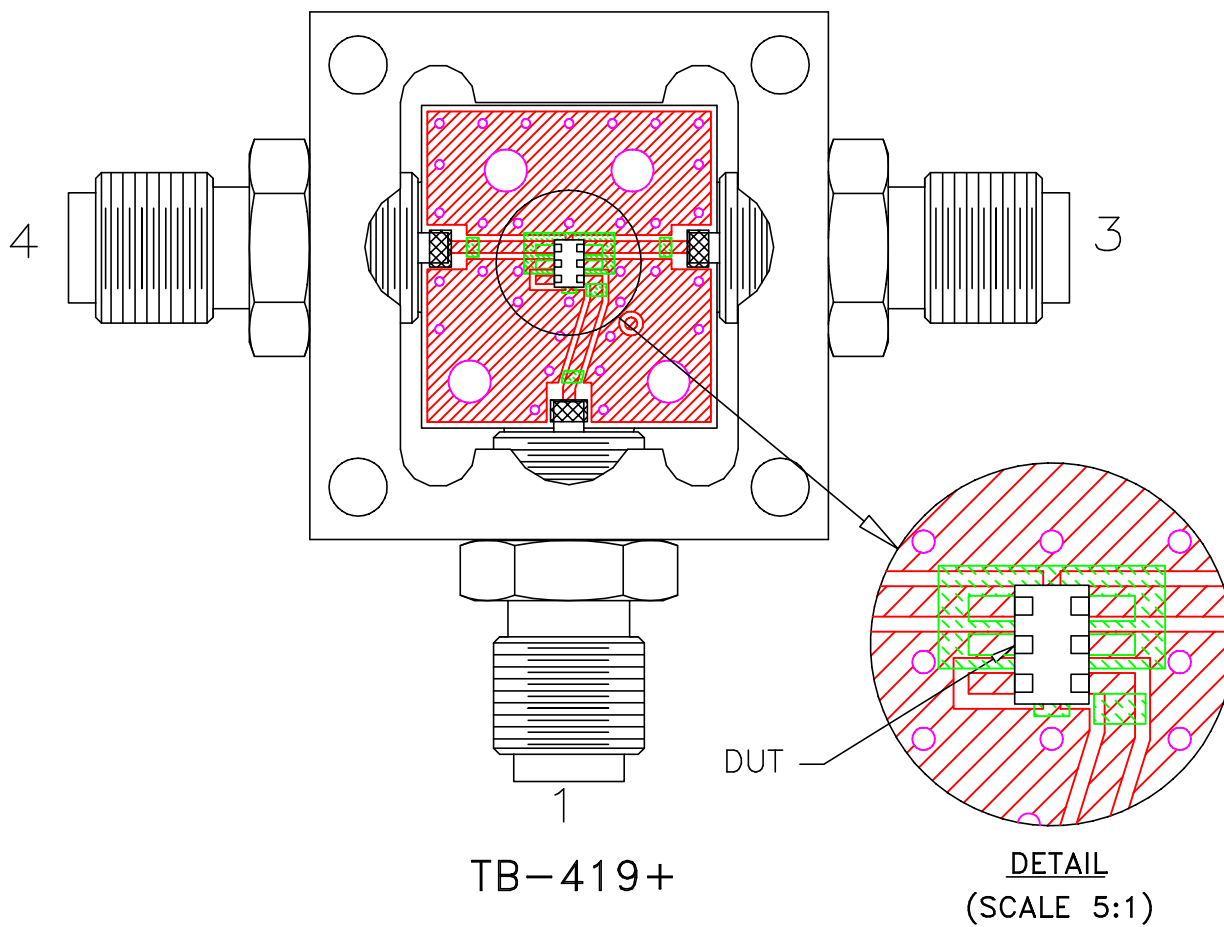
PL, ry, GE0805C-1, NCS, TB-419+

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SIZE A	CODE IDENT 15542	DRAWING NO: 98-PL-264	REV: OR
FILE: 98PL264	SCALE: 10:1	SHEET: 1 OF 1	

Evaluation Board and Circuit


For Pin Connections refer to Data Sheet of the DUT



Schematic Diagram

Notes:

1. SMA Female connectors.
2. PCB Material: Rogers R04350 or equivalent, Dielectric Constant=3.5, Thickness=.010 inch.

 **Mini-Circuits®**



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Solder Reflow Heat	Sn-Pb Eutectic Process: 225°C peak Pb-Free Process: 250°C peak	J-STD-020C, Table 4-1, 4-2 and 5-2; Figure 5-1
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A